

3571723

Worlds Best Performance 3D Solder Paste Inspection



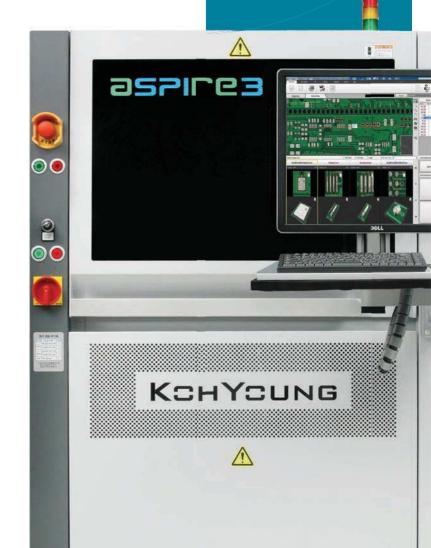
Ultra High Speed



Complete Process Solutions



Highest Accuracy









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Setting a Higher Standard with Metrology-Level 3D Inspection





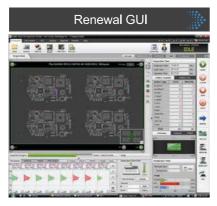
Fast 03015 Components Inspection

- Accurate and repeatable measurement values with doubled throughput
- Unrivalled and unique 03015 measurement capability helping realize today's IT innovations



True 3D Foreign Material Inspection on Whole PCB Area

- Optimized display for the user with smart menu groupings
- Supports user's defect readability and system usability by more intuitive software
- Detects a wide range of defects using real images and 3D data







Integrated SW Solutions to Realize Fully Automated Process Optimization: Industry 4.0



LM(Library Manager) @ KSMART



Job Management

- Store & distribute Job files and inspection conditions from centralized DB to multiple SPIs
- Changes and modifications after process optimization are easier to manage

User Level Management

- · Can set up user level groups with different authorities
- Each user's work history is traceable via user log data



Link@KSMART

Optional 🗹

3D data based SPI-AOI communication solution

- Review, diagnosis and optimization of printing, pick-and-place and reflow process
- Traces root cause of defects by storing and communicating inspection results from Koh Young's 3D SPI and 3D AOI Systems





Auto-Verification



Maintain Optimal Machine Conditions

- Periodical checks on critical items
 - : 2D/3D Light Intensity, PZT Feed, Height Accuracy, XY Offset
- · Guide users to take preventive actions so that SPI can maintain optimal conditions

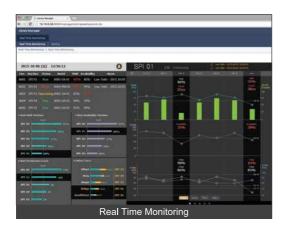
Minimum Downtime for Maintenance

Auto-verify machine conditions during operation to reduce unwanted machine downtime



Real Time Monitoring





Process Optimization

- Provides analysis data for real-time multi-line management
- Provides comparison data of each machines and lines
- Manage machine status for all production lines from remote locations

Multi-line Production Info

- · Machine status, model info, yield, alarm
- Best production, yield, availability machine ranking chart and defect top 5 info
- Detailed history chart
 - : Height, Volume, Offset for the selected line

[™] Must-check Requirements for a 3D SPI System



Requirements		Solutions		
Shadow Pro	oblem Solution			
Specular Pr	roblem Solution			
Reference Plane Shadow Solution		 3D Shadow Free Moiré Technology & 4 Way Projection 		
Directional I	Problem Solution			
Real Time F	PCB Warp compensation (2D+3D Solution)	Warp Compensation (Pad Referencing	n + 7-tracking)	
Operator User-friendliness		Renewal GUI, Real Color 3D Image		
Foreign Material Inspection				
Foreign iviat	terial Inspection	3D Foreign Material Inspection		
Inspection Items	Metrology Capability	Volume, Area, Height, Offset, Bridging, Shape Deformity, Coplanarity		
	Types of Defects	• Insufficient/Excessive/Missing Paste, Bridging, Shape Deformity, Paste Offset, Coplanarity		
	Camera Resolution	10 μm	15 μm	
Inspection Performance	FOV Size	40.96 x 30.72 mm (1.61 × 1.21 inch)	61.44 × 46.08 mm (2.42 × 1.81 inch)	
	Full 3D Inspection Speed	29 ~ 63 cm²/sec		
	Camera	• 12M Pixel Camera		
	Illumination	IR-RGB LED Dome Styled Illumination		
	Z Resolution	• 0.37 μm		
	Height Accuracy (on KY Calibration target)	• 1 µm		
	01005 Inspection Capacity Gage R&R (±50% tolerance)	< 10% at 6σ		
	Max. Inspection Size	• 10 × 10 mm	0.39×0.39 inch	
	Min. Distance between PADs	 100 μm (150 μm paste height) 	3.94 mils (5.91 mils paste height)	
	Various colored PCB Inspection	Possible		
РСВ	Conveyor Width Adjustment	Automatic		
Handling	Conveyor Fix Type	Front / Rear Fixed (factory setting)		
	Supported Input Format	 GERBER Data (274X, 274D), ODB++ 		
	Programming S/W	• ePM-SPI		
		SPC@KSMART Histogram, Y har & P. Chart, Y har & S.	Chart Cn & Cnk % Gago P&P	
	Statistical Process Control Tool	 Histogram, X-bar & R-Chart, X-bar & S-Chart, Cp & Cpk, %Gage R&R Real Time SPC & Multiple Display 		
Software		- SPC Alarm		
		Remote Monitoring System		
		 Library Manager@KSMART 		
	Operator User-friendliness	 KYCal: Auto Camera Calibration, Auto Illumination Calibration, Auto Height Calibration 		
	Operating System	Windows 7 Ultimate 64bit		
Add-on Solutions	1D & 2D Handy Barcode Reader	Offline SPC Plus Station	Review Station	
	1D & 2D Inline Barcode Reader	Standard Calibration Target	KSMART Process Optimizer	
	Offline Programming Station	Remote Monitoring System	• UPS	
	Auto Verification	Link@KSMART	Panasonic APC	
	• ODB++	• SPC@KSMART	 Real Time Monitoring 	

* Above specifications are subject to change without notice.

	L		XL	
	Single Lane	Dual Lane	Single Lane	Dual Lane
Max. PCB Size	490 x 510 mm (19.2 x 20 inch)	490 x 580 mm (19.2 x 22.8 inch)	830 x 690 mm (32.6 x 27.1 inch)	Single Mode : 830 x 580 mm (32.6 x 22.8 inch) Dual Mode : 830 x 320 mm (32.6 x 12.5 inch)
Min. PCB Size	50 x 50 mm (1.96 x 1.96 inch)		70 x 70 mm (2.75 x 2.75 inch)	
PCB Thickness	0.4 ~ 5 mm (0.01 ~ 0.19 inch)		0.6 ~ 8 mm (0.02 ~ 0.31 inch)	
Max. PCB Weight	5 kg (11 lbs)		10 kg (22 lbs)	
Machine Weight	600 kg (1322 lbs)	650 kg (1433 lbs)	850 kg (1874 lbs)	900 kg (1984 lbs)
W	1000 mm (39.3 inch)	1000 mm (39.3 inch)	1350 mm (53.1 inch)	1350 mm (53.1 inch)
D	1280 mm (50.4inch)	1460 mm (57.4 inch)	1460 mm (57.4 inch)	1460 mm (57.4 inch)
Н	1727 mm (67.9 inch)	1727 mm (67.9 inch)	1727 mm (67.9 inch)	1727 mm (67.9 inch)
F	985 mm (38.7 inch)	985 mm (38.7 inch)	1165 mm (45.8 inch)	1165 mm (45.8 inch)
Supplies 200~240VAC, 50/60Hz Single Phase, 5Kgf/cm²				

